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Part Number:

0736441002

Status:

Active

Overview:

[hdm](#)

Description:

2.00mm (.079") Pitch HDM® Board-to-Board Backplane Header, Vertical, SMC, Press-Fit, Guide Post Location B, Polarizing Key Position B, 144 Circuits

Documents:

[Drawing \(PDF\)](#)

[RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA	LR19980
UL	E29179

General

Product Family	Backplane Connectors
Series	73644
Application	Backplane
Comments	Standard Press-Fit
Component Type	PCB Header
Overview	hdm
Product Name	HDM®
Style	N/A

Physical

Circuits (Loaded)	144
Circuits (maximum)	144
Color - Resin	Black, Natural
Durability (mating cycles max)	250
First Mate / Last Break	No
Flammability	94V-0
Guide to Mating Part	Yes
Keying to Mating Part	Yes
Material - Metal	Phosphor Bronze, Stainless Steel
Material - Plating Mating	Gold
Material - Plating Termination	Gold
Material - Resin	High Temperature Thermoplastic
Number of Columns	24
Number of Pairs	Open Pin Field
Number of Rows	6
Orientation	Vertical
PC Tail Length (in)	0.138 In
PC Tail Length (mm)	3.50 mm
PCB Locator	No
PCB Retention	Yes
PCB Thickness Recommended (in)	0.098 In
PCB Thickness Recommended (mm)	2.50 mm
Packaging Type	Tube
Pitch - Mating Interface (in)	0.079 In
Pitch - Mating Interface (mm)	2.00 mm
Pitch - Term. Interface (in)	0.079 In
Pitch - Term. Interface (mm)	2.00 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.75
Plating min: Termination (µin)	2
Plating min: Termination (µm)	0.05
Polarized to PCB	No



image - Reference only

Series

EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Contains SVHC: No
Halogen-Free
Status
Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[73644Series](#)

Mates With
[73632](#) HDM PLUS® Board-to-Board Daughtercard Receptacle. [73780](#) HDM® Board-to-Board Daughtercard Receptacle

Application Tooling | FAQ
Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global	
Description	Product #
Flat Rock Tooling for	0622013700
Pneumatic Press	
HDM® Backplane	0621001400
Insertion Signal	
Contact Tool	
HDM® Backplane	0622005703
Insertion Head for	
144 Positions	

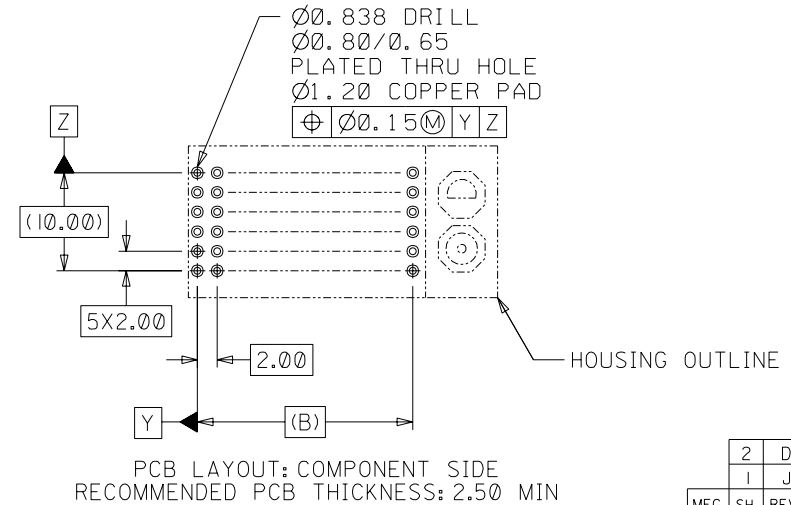
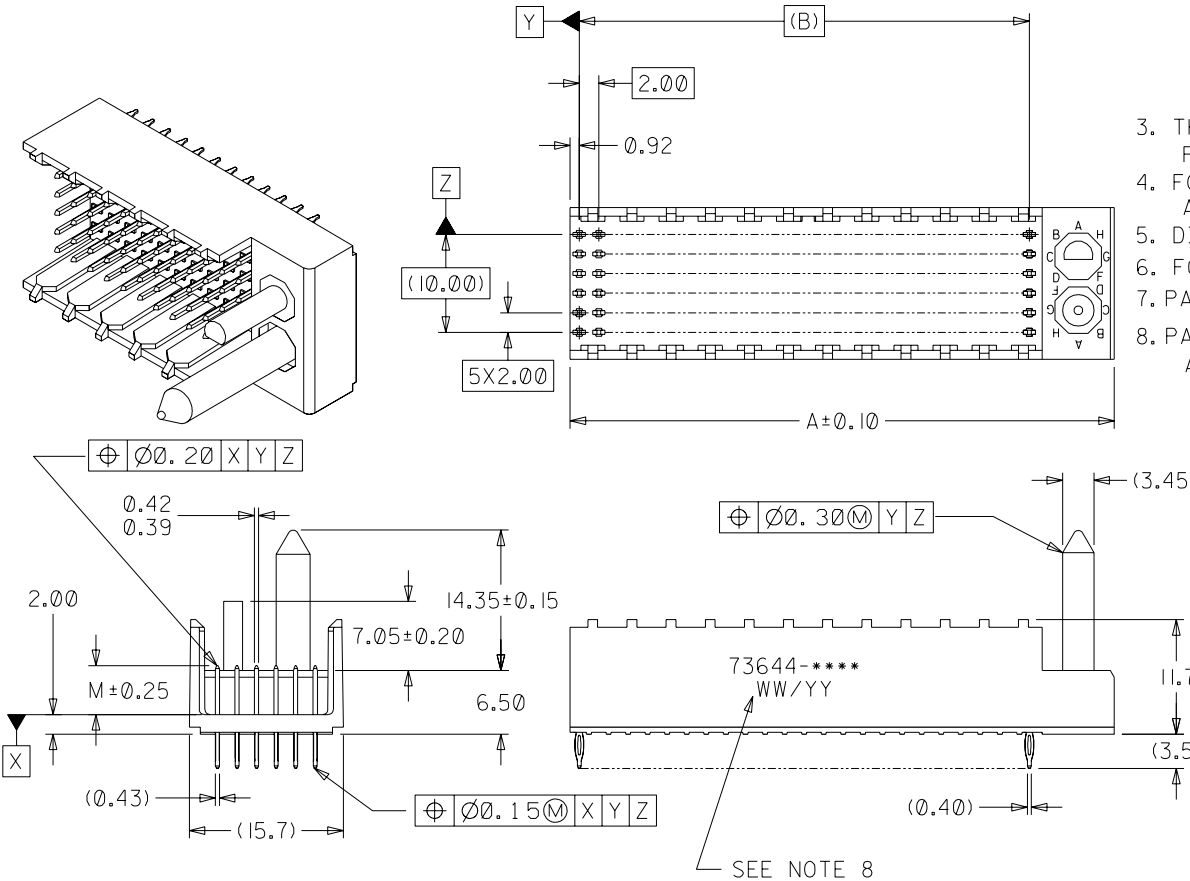
Stackable	No	Extraction Tool	0621001000
Surface Mount Compatible (SMC)	Yes		
Temperature Range - Operating	-55°C to +105°C		
Termination Interface: Style	Through Hole - Compliant Pin		
Electrical			
Current - Maximum per Contact	1A		
Data Rate	1.0 Gbps		
Real Signals (per 25mm)	75		
Shielded	No		
Voltage - Maximum	250V AC		
Material Info			
Reference - Drawing Numbers			
Packaging Specification	PK-70873-0818		
Sales Drawing	SDA-73644-****		
HDM and High Density Metric are trademarks of Amphenol Corporation			

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NOTES:

1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), GLASS-FILLED, UL94V-0, COLOR: BLACK, TERMINAL - PHOSPHOR BRONZE.
2. FINISHES: SELECTIVE GOLD (Au) IN CONTACT AREA, 0.00076mm MINIMUM THICKNESS; NICKEL (Ni) AND GOLD FLASH OVERALL SELECTIVE GOLD (Au) IN CONTACT AREA, 0.00076mm MIN. THICKNESS; SELECTIVE TIN/LEAD (Sb/Pb) IN TAIL AREA; NICKEL (Ni) OVERALL.
3. THIS PART CONFORMS TO MOLEX PRODUCT SPECIFICATION PS-73670-9999.
4. FOR MIXED CONTACT MATING LENGTHS, CONSULT FACTORY FOR AVAILABILITY.
5. DIMENSIONS ARE IN MILLIMETERS.
6. FOR SPECIFIC MATERIAL NUMBERS, REFER TO SHEET 2.
7. PACKAGE PER PK-70873-0818.
8. PARTS MARKED WITH PART NUMBER AND DATE CODE, ON EITHER SIDE, APPROXIMATELY WHERE SHOWN.



PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: 2.50 MIN

2	D
1	J
MFG.	SH. REV.

REVISED ECR UDT2000-0348 BINGHAM 99/10/12	I
REVISED ECR UDT1999-0662 BINGHAM 99/05/18	H
REVISED ECR UDT1999-0476 BINGHAM 98/12/21	G
REVISED ECR UCP2003-2260 THOMAS 03/04/25	J
LTR.	REVISIONS

DIMENSIONS SHOWN (METRIC) INCH
UNLESS OTHERWISE SPECIFIED TOLERANCES: ANGULAR ± 1/2°
INCH METRIC
3 PLACE ± N/A ---
2 PLACE ± N/A ± 0.05
1 PLACE --- ± 0.10
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS
DRWG. BY: JRR CHK'D. BY: SMR
APP'D. BY: CAB SCALE: 2 : 1

SALES ASSY, HDM BACKPLANE MODULE, POLAR/GUIDE OPTION
MOLEX INCORPORATED LITSE,ILL. 60532
SHEET NO. 1 OF 2 DATE 96/12/18
PART NO. SEE CHART SDA-73644-****
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.
DIV. DA SIZE B

10		9	8	7	6		7364
F	MATERIAL NUMBER	NUMBER OF SIGNAL CONTACTS	PLATING		DIM "A"	DIM "B"	DIM "M"
	73644-00**	72	SELECTIVE GOLD/GOLD FLASH		31.60	22.00	5.00
	73644-01**	72	SELECTIVE GOLD/GOLD FLASH		31.60	22.00	5.50
	73644-02**	72	SELECTIVE GOLD/GOLD FLASH		31.60	22.00	6.00
	73644-10**	144	SELECTIVE GOLD/GOLD FLASH		55.60	46.00	5.00
	73644-11**	144	SELECTIVE GOLD/GOLD FLASH		55.60	46.00	5.50
	73644-12**	144	SELECTIVE GOLD/GOLD FLASH		55.60	46.00	6.00
E	73644-20**	72	SELECTIVE GOLD/SELECTIVE TIN-LEAD		31.60	22.00	5.00
	73644-21**	72	SELECTIVE GOLD/SELECTIVE TIN-LEAD		31.60	22.00	5.50
	73644-22**	72	SELECTIVE GOLD/SELECTIVE TIN-LEAD		31.60	22.00	6.00
	73644-30**	144	SELECTIVE GOLD/SELECTIVE TIN-LEAD		55.60	46.00	5.00
	73644-31**	144	SELECTIVE GOLD/SELECTIVE TIN-LEAD		55.60	46.00	5.50
	73644-32**	144	SELECTIVE GOLD/SELECTIVE TIN-LEAD		55.60	46.00	6.00

MATERIAL NUMBER ASSIGNMENT

73644- * * * *

0 = 72-CIRCUIT, GOLD/GOLD FLASH
1 = 144-CIRCUIT, GOLD/GOLD FLASH
2 = 72-CIRCUIT, GOLD/TIN-LEAD
3 = 144-CIRCUIT, GOLD/TIN-LEAD

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0 = 5.00 MATING LENGTH
1 = 5.50 MATING LENGTH
2 = 6.00 MATING LENGTH
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REF. MATERIAL NUMBER 73644-0009
GUIDE PIN IS IN LOCATION A
POLARIZING KEY IS IN LOCATION B. POSITION F



REF. MATERIAL NUMBER 73644-0008
GUIDE PIN IS IN LOCATION B
POLARIZING KEY IS IN LOCATION A, POSITION E

NUMBER	GUIDE POST LOCATION	POLAR KEY POSITION
00	B	A
01	A	
02	B	B
03	A	
04	B	C
05	A	
06	B	D
07	A	
08	B	E
09	A	
10	B	F
11	A	
12	B	G
13	A	
14	B	H
15	A	
16	B	N/A
17	A	
18	N/A	

[illegible]

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- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
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- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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